#### Construction of an Actively Cooled MAPS Device operated in vacuum near a storage ring beam

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## A word on the PANDA Experiment



## A word on the PANDA Experiment



# A word on the $\overline{\mathsf{P}}\mathsf{ANDA}$ Experiment





#### Measurement close to the Beam

#### Requirements for the detector:

minimal track distortion by material maximum acceptance elastic events

measurement at smallest angles

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#### Requirements by the storage ring:

high vacuum < 10<sup>-9</sup> mbar

maximum acceptance of the beam

slow changes of beam pipe diameter



## **PANDA** beam pipe



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#### Vacuum Box Prototype



## Beam Pipe Prototype



#### **Differential Pumping Scheme**



## First Pumping Tests



#### First Pumping Tests



#### Observations during vacuum tests



Lessons learned: keep the number of ports and connections as small as possible! (Not discussed) Permeability of the transition foil is not negligible.

#### **Retractable Detector Halves**



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#### **Displacement Measurement in Vacuum**

Capacitive probes: *Capacitec 208-ACU* 

2 mm range ~ 40 nm resolution

Aquisition via 18-bit differential ADC and microcontroller with CAN interface

-> final resolution ~(400-500)nm









#### Linearity of the linear shift mechanism



Lesson: High resolution does not necessarily mean a high linearity!



#### Cooling of HV-MAPS

 $2 \ x \ 2 \ cm^2$  individual HV-MAPS (50  $\mu m)$  400 in total

2011

digitization on chip

expected power consumption : 2 mW/mm<sup>2</sup>

glued on a diamond wafer (200 μm) (high thermal conductivity)

module

tracking plane

#### Section through one side of a Plane



### Simulations on cooling



#### Simulations vs. Reality



Testing contact materials for the module clamp and a copper dummy

#### Simulations vs. Reality



#### Simulations vs. Reality



#### A Support Structure as a Heat Sink



#### **Production of Heat Sink Supports**



Original idea: LHCb Velo Detector

melting AlMg4.5Mn alloy for 730°C 90 min in argon atmosphere





#### **Production of Heat Sink Supports**



#### Temperature uniformity tests



Trapped air bubbles are removed by evacuation procedure prior to coolant fludding. Observations: Temperature increase by 3° between inlet and outlet without applied loads! Heat from Radiation? Contact of temperature sensors? Turbulences?



# Always perform experimental tests (specially if you have doubts)

# Thank you

#### **Differential Pumping Sheme**



### Cooling stations for cooling liquids



versus

Cooling power @-20°C 1.9 kW 2.2kW max. pumping speed 105 l/min 45 l/min max. pumping pressure 2.5 bar(special version) 2.9 bar



#### Setting up a distributed cooling circuit



Testing the tightness with 4 bar overpressure (argon)



#### **Geometrical Acceptance**



Acceptance at 1.5 GeV/c beam momentum





Welding tube inside



Melting in a copper mold



P3 ,



Melting in a SS mold with inert gas

# The biggest fun we had: *"Baking cookies"*

Question was: Can we melt aluminum cooling blocks around a stainless steel pipe?

Prototype 5: Vacuum

melting / pressurized

freezing.. Perfect!

– As Aluminum crimps more we must get a nice crimp contact though?

Prototype 4: Mg vapor bubbles due to vacuum





Applied vacuum method bonded SS to Alu by diffusion of Fe into Al



Result of vacuum baking: A: Perfect contact around the pipe, B: perfect contra shape of the mold

- Aluminum cookie recipe:
  - Take a stainless steel tin and fill with aluminum blocks or bars (AIMg4,5Mn)
    - Melt aluminum under vacuum <1e-3 mbar at 700°C for 1.5 hour</li>
  - Apply 1 bar Argon pressure for 10 minutes
  - Switch of oven and let cool down.
  - Remove cookies from the mold and machine

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# "The cookie bakery"





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#### First Pumping Tests

